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# CGHV22100 100 W, 1800-2200 MHz, GaN HEMT for LTE

Cree's CGHV22100 is a gallium nitride (GaN) high electron mobility transistor (HEMT) is designed specifically for high efficiency, high gain and wide bandwidth capabilities, which makes the CGHV22100 ideal for 1.8 - 2.2 GHz LTE, 4G Telecom and BWA amplifier applications. The transistor is input matched and supplied in a ceramic/ metal flange package.



Package Type: 440162 and 440161 PN: CGHV22100F and CGHV22100P

#### Typical Performance Over 1.8 - 2.2 GHz ( $T_c = 25^{\circ}c$ ) of Demonstration Amplifier

Parameter	1.8 GHz	2.0 GHz	2.2 GHz	Units
Gain @ 44 dBm	18.7	20.7	22.0	dB
ACLR @ 44 dBm	-37.8	-37.1	-35.1	dBc
Drain Efficiency @ 44 dBm	35.4	31.7	30.6	%

#### Note:

Measured in the CGHV22100-AMP amplifier circuit, under WCDMA 3GPP test model 1, 64 DPCH, 45% clipping, PAR = 7.5 dB @ 0.01% Probability on CCDF.

#### Features

- 1.8 2.2 GHz Operation
- 20 dB Gain
- -35 dBc ACLR at 25 W P<sub>AVE</sub>
- + 31-35 % Efficiency at 25 W  $P_{AVE}$
- High Degree of DPD Correction Can be Applied









#### Absolute Maximum Ratings (not simultaneous) at 25°C Case Temperature

Parameter	Symbol	Rating	Units	Conditions
Drain-Source Voltage	V <sub>DSS</sub>	125	Volts	25°C
Gate-to-Source Voltage	V <sub>GS</sub>	-10, +2	Volts	25°C
Storage Temperature	T <sub>stg</sub>	-65, +150	°C	
Operating Junction Temperature <sup>3</sup>	Tj	225	°C	
Maximum Forward Gate Current	I <sub>GMAX</sub>	16	mA	25°C
Maximum Drain Current <sup>1</sup>	I <sub>DMAX</sub>	6	А	25°C
Soldering Temperature <sup>2</sup>	Τ <sub>s</sub>	245	°C	
Screw Torque	τ	80	in-oz	
Thermal Resistance, Junction to Case <sup>3</sup>	R <sub>ejc</sub>	2.34	°C/W	85°C, P <sub>DISS</sub> = 48 W
Thermal Resistance, Junction to Case <sup>4</sup>	R <sub>ejc</sub>	2.95	°C/W	85°C, P <sub>DISS</sub> = 48 W
Case Operating Temperature <sup>5</sup>	T <sub>c</sub>	-40, +150	°C	

#### Note:

<sup>1</sup> Current limit for long term, reliable operation.

<sup>2</sup> Refer to the Application Note on soldering at http://www.cree.com/rf/document-library

<sup>3</sup> Measured for the CGHV22100P

 $^{\scriptscriptstyle 4}$  Measured for the CGHV22100F

<sup>5</sup> See also, the Power Dissipation De-rating Curve on Page 4.

### Electrical Characteristics ( $T_c = 25^{\circ}C$ )

Characteristics	Symbol	Min.	Тур.	Max.	Units	Conditions
DC Characteristics <sup>1</sup>						
Gate Threshold Voltage	$V_{\text{GS(th)}}$	-3.8	-3.0	-2.3	V <sub>DC</sub>	$V_{_{\rm DS}}$ = 10 V, I <sub>D</sub> = 16 mA
Gate Quiescent Voltage	$V_{GS(Q)}$	-	-2.7	-	V <sub>DC</sub>	$V_{_{\rm DS}}$ = 50 V, I <sub>D</sub> = 0.5 A
Saturated Drain Current <sup>2</sup>	I <sub>DS</sub>	12	14.4	-	А	$V_{\rm DS}$ = 6.0 V, $V_{\rm GS}$ = 2.0 V
Drain-Source Breakdown Voltage	V <sub>BR</sub>	150	-	-	V <sub>DC</sub>	$V_{_{\rm GS}}$ = -8 V, I $_{_{\rm D}}$ = 16 mA
RF Characteristics <sup>3</sup> ( $T_c = 25^{\circ}C$ , $F_0 = 2.17$ G	Iz unless other	wise noted)				
Gain⁴	G	19.75	22	-	dB	$V_{_{DD}}$ = 50 V, I $_{_{DQ}}$ = 0.5 A, $P_{_{OUT}}$ = 44 dBm
WCDMA Linearity <sup>4</sup>	ACLR	-	-35	-31	dBc	$V_{_{DD}}$ = 50 V, I $_{_{DQ}}$ = 0.5 A, $P_{_{OUT}}$ = 44 dBm
Drain Efficiency <sup>4</sup>	η	26.5	30.5	-	%	$V_{_{DD}}$ = 50 V, I $_{_{DQ}}$ = 0.5 A, $P_{_{OUT}}$ = 44 dBm
Output Mismatch Stress	VSWR	-	-	10:1	Ψ	No damage at all phase angles, V_{_{DD}} = 50 V, I $_{_{DQ}}$ = 0.5 A, P $_{_{OUT}}$ = 100 W Pulsed
Dynamic Characteristics						
Input Capacitance <sup>5</sup>	C <sub>GS</sub>	-	66	-	pF	$V_{_{DS}}$ = 50 V, $V_{_{gs}}$ = -8 V, f = 1 MHz
Output Capacitance <sup>5</sup>	C <sub>DS</sub>	-	8.7	-	pF	$V_{_{DS}}$ = 50 V, $V_{_{gs}}$ = -8 V, f = 1 MHz
Feedback Capacitance	C <sub>GD</sub>	-	0.47	-	pF	$V_{_{DS}}$ = 50 V, $V_{_{gs}}$ = -8 V, f = 1 MHz

#### Notes:

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<sup>1</sup> Measured on wafer prior to packaging.

<sup>2</sup> Scaled from PCM data.

<sup>3</sup> Measured in CGHV22100-AMP

<sup>4</sup> Single Carrier WCDMA, 3GPP Test Model 1, 64 DPCH, 45% Clipping, PAR = 7.5 dB @ 0.01% Probability on CCDF.

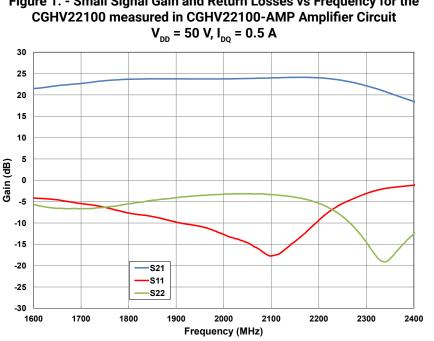
<sup>5</sup> Includes package and internal matching components.

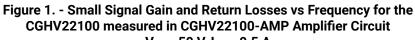
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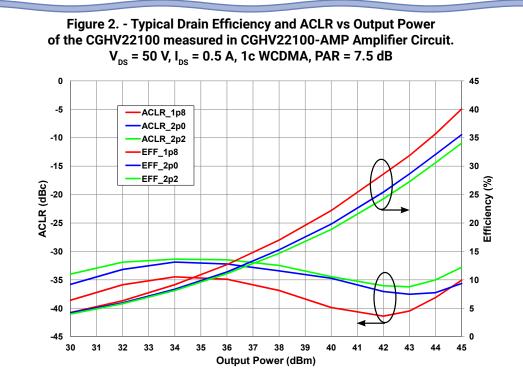


#### **Typical Performance**





#### **Typical Linear Performance**

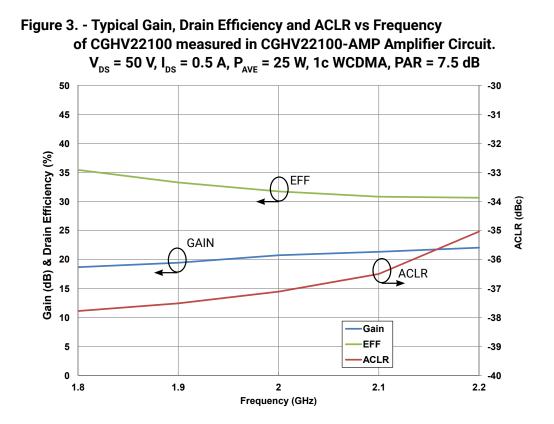


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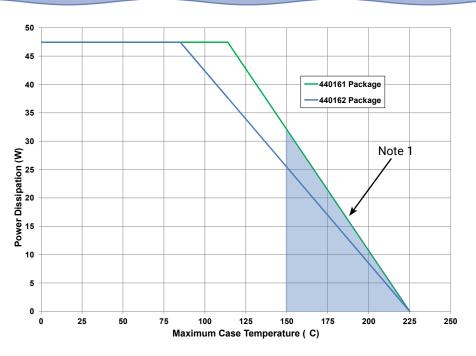
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**Typical Performance** 



CGHV22100 Power Dissipation De-rating Curve



Note 1. Area exceeds Maximum Case Operating Temperature (See Page 2).

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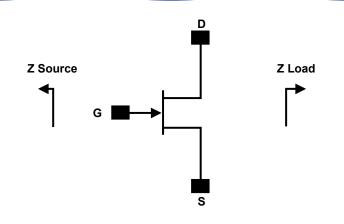
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#### **Source and Load Impedances**



Frequency (MHz)	Z Source	Z Load
1800	4.50 + j0.91	5.21 - j2.58
1900	5.20 + j1.15	5.01 - j2.09
2000	6.02 + j1.03	4.85 - j1.61
2100	6.75 + j0.42	4.70 - j1.12
2200	7.03 - j0.64	4.58 - j0.62

Note<sup>1</sup>:  $V_{DD}$  = 50 V,  $I_{DQ}$  = 0.5 A. In the 440162 package. Note<sup>2</sup>: Impedances are extracted from CGHV22100-AMP demonstration circuit and are not source and load pull data derived from transistor.

#### **Electrostatic Discharge (ESD) Classifications**

Parameter	Symbol	Class	Test Methodology
Human Body Model	НВМ	1A (> 250 V)	JEDEC JESD22 A114-D
Charge Device Model	CDM	2 (125 V to 250 V)	JEDEC JESD22 C101-C

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#### CGHV22100-AMP1 Demonstration Amplifier Circuit Bill of Materials

Designator	Description	Qty
R1	RES, 1/16 W, 0603, 1%, 10.0 OHMS	1
R2	RES, 1/16 W, 0603, 1%, 5.1 OHMS	1
C4, C14, C24	CAP, 470 pF, 5%, 100 V, 0603, X	3
C6,C16, C26	CAP, 1.0 UF, 100 V, 10%, x7R, 121	3
C17, C27	CAP, 100 UF, 20%, 160 V, ELEC	2
C7	CAP, 10 UF, 16 V, TANTALUM, 2312	1
C1, C2, C3, C13, C23	CAP, 10.0 pF, 5%, 0603, ATC	5
C5, C15, C25	CAP, 33000 pF, 0805, 100 V, X7R	3
C11	CAP, 10 pF, 5%, 250 V, 0805, A	1
J1, J2	CONN, N, FEM, W/.500 SMA FLNG	2
J3	HEADER RT>PLZ .1CEN LK 9POS	1
	BASEPLATE, CGH35120	
	PCB, CGHV22100F, RO4350	1
	2-56 SOC HD SCREW 1/4 SS	4
	#2 SPLIT LOCKWASHER SS	4
	CGHV22100F	1

#### CGHV22100-AMP Demonstration Amplifier Circuit



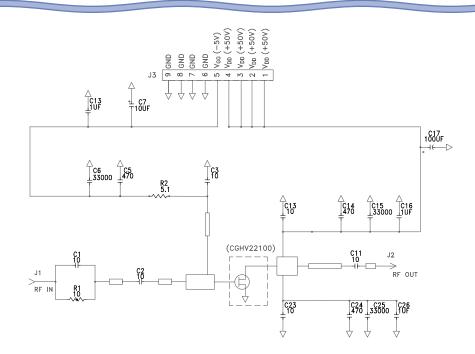
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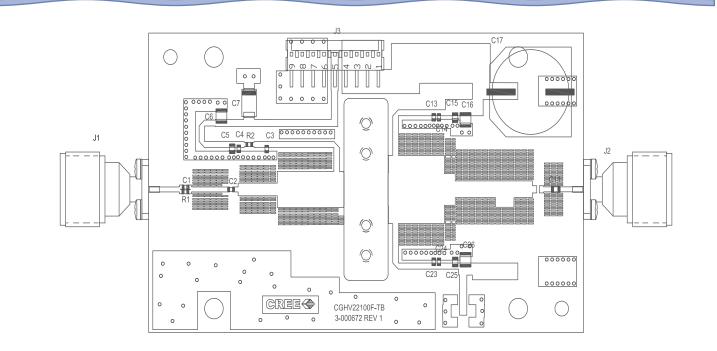
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#### CGHV22100-AMP Demonstration Amplifier Circuit Schematic



#### CGHV22100-AMP Demonstration Amplifier Circuit Outline

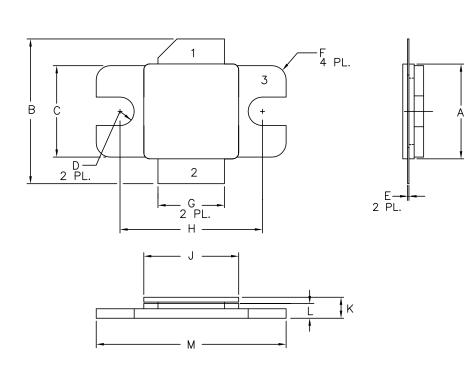


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## Product Dimensions CGHV22100 (Package Type – 440162)



NOTES:

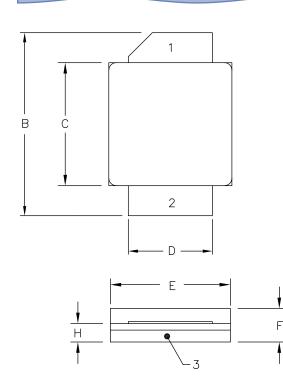
- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCH.
- 3. ADHESIVE FROM LID MAY EXTEND A MAXIMUM OF 0.020" BEYOND EDGE OF LID.
- 4. LID MAY BE MISALIGNED TO THE BODY OF THE PACKAGE BY A MAXIMUM OF 0.008" IN ANY DIRECTION.

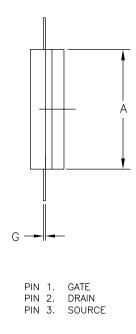
	INC	HES	MILLIM	ETERS
DIM	MIN	MAX	MIN	MAX
А	.395	.405	10.03	10.29
В	.580	.620	14.73	15.75
С	.380	.390	9.65	9.91
D	.055	.065	1.40	1.65
E	.004	.006	0.10	0.15
F	.055	.065	1.40	1.65
G	.275	.285	6.99	7.24
н	.595	.605	15.11	15.37
J	.395	.405	10.03	10.29
к	.129	.149	3.28	3.78
L	.053	.067	1.35	1.70
м	.795	.805	20.19	20.45

PIN 1. PIN 2. PIN 3. GATE DRAIN

SOURCE

#### Product Dimensions CGHV22100 (Package Type - 440161)





#### NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCH.
- 3. ADHESIVE FROM LID MAY EXTEND A MAXIMUM OF 0.020" BEYOND EDGE OF LID.
- LID MAY BE MISALIGNED TO THE BODY OF PACKAGE BY A MAXIMUM OF 0.008" IN ANY DIRECTION.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	.395	.407	10.03	10.34
В	.594	.634	15.09	16.10
С	.395	.407	10.03	10.34
D	.275	.285	6.99	7.24
E	.395	.407	10.03	10.34
F	.129	.149	3.28	3.78
G	.004	.006	0.10	0.15
н	.057	.067	1.45	1.70

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Part Number System



Value	Units
2.2	GHz
100	W
Flange	-
	2.2 100

Table 1.

**Note**<sup>1</sup>: Alpha characters used in frequency code indicate a value greater than 9.9 GHz. See Table 2 for value.

Character Code	Code Value
А	0
В	1
С	2
D	3
E	4
F	5
G	6
Н	7
J	8
К	9
Examples:	1A = 10.0 GHz 2H = 27.0 GHz

Table 2.

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### **Product Ordering Information**

Order Number CGHV22100F	Description GaN HEMT	Unit of Measure Each	Image
CGHV22100P	GaN HEMT	Each	CRIER COP CGH V22100P CGH V220028
CGHV22100-TB	Test board without GaN HEMT	Each	
CGHV22100F-AMP	Test board with GaN HEMT installed	Each	

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